

NPN SILICON RF TRANSISTOR 2SC5185

NPN EPITAXIAL SILICON RF TRANSISTOR FOR HIGH-FREQUENCY LOW-NOISE AMPLIFICATION 4-PIN SUPER MINIMOLD

FEATURES

· Low Noise

NF = 1.3 dB TYP. @ $V_{CE} = 2 \text{ V}$, $I_{C} = 3 \text{ mA}$, f = 2 GHzNF = 1.3 dB TYP. @ $V_{CE} = 1 \text{ V}$, $I_{C} = 3 \text{ mA}$, f = 2 GHz

• 4-pin super minimold Package

★ ORDERING INFORMATION

Part Number	Quantity	Supplying Form	
2SC5185	50 pcs (Non reel)	• 8 mm wide embossed taping	
2SC5185-T1	3 kpcs/reel	Pin 3 (Base), Pin 4 (Emitter) face to perforation side of the tape	

Remark To order evaluation samples, contact your nearby sales office.

The unit sample quantity is 50 pcs.

ABSOLUTE MAXIMUM RATINGS ($T_A = +25$ °C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vcво	5	٧
Collector to Emitter Voltage	Vceo	3	٧
Emitter to Base Voltage	VEBO	2	V
Collector Current	lc	30	mA
Total Power Dissipation	Ptot Note	90	mW
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-65 to +150	°C

Note Free air

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

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The mark \star shows major revised points.

Printed in Japan



ELECTRICAL CHARACTERISTICS (TA = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit		
DC Characteristics								
Collector Cut-off Current	Ісво	VcB = 5 V, IE = 0 mA	-	-	100	nA		
Emitter Cut-off Current	ІЕВО	V _{EB} = 1 V, I _C = 0 mA	-	-	100	nA		
DC Current Gain	hfe Note 1	VcE = 2 V, Ic = 20 mA	70	-	140	-		
RF Characteristics								
Gain Bandwidth Product (1)	f⊤	VcE = 2 V, Ic = 20 mA, f = 2.0 GHz	10	13	-	GHz		
Gain Bandwidth Product (2)	f⊤	VcE = 1 V, Ic = 10 mA, f = 2.0 GHz	8.0	11	-	GHz		
Insertion Power Gain (1)	S _{21e} ²	VcE = 2 V, Ic = 20 mA, f = 2.0 GHz	8.0	11	-	dB		
Insertion Power Gain (2)	S _{21e} ²	VcE = 1 V, Ic = 10 mA, f = 2.0 GHz	7.5	9.0	-	dB		
Noise Figure (1)	NF	VcE = 2 V, Ic = 3 mA, f = 2.0 GHz	-	1.3	2.0	dB		
Noise Figure (2)	NF	VcE = 1 V, Ic = 3 mA, f = 2.0 GHz	-	1.3	2.0	dB		
Reverse Transfer Capacitance	Cre Note 2	VcB = 2 V, IE = 0 mA, f = 1.0 MHz	-	0.3	0.6	pF		

Notes 1. Pulse measurement: PW \leq 350 μ s, Duty Cycle \leq 2%

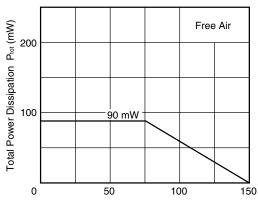
2. Collector to base capacitance when the emitter grounded

hfe CLASSIFICATION

Rank	FB		
Marking	T86		
h _{FE} Value	70 to 140		

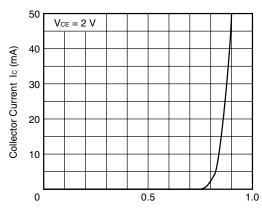
TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



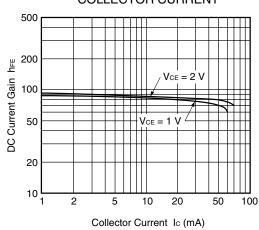
Ambient Temperature TA (°C)

COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



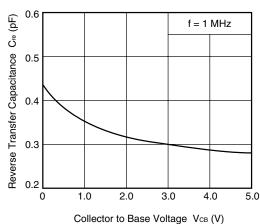
Base to Emitter Voltage VBE (V)

DC CURRENT GAIN vs. COLLECTOR CURRENT

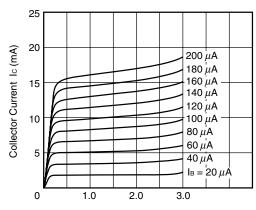


Remark The graphs indicate nominal characteristics.

REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE

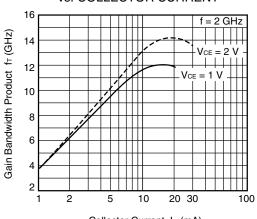


COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



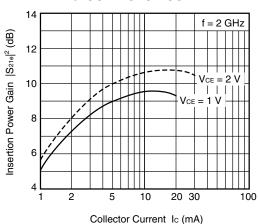
Collector to Emitter Voltage VcE (V)

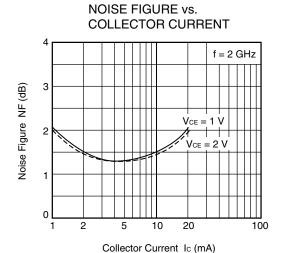
GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT



Collector Current Ic (mA)

INSERTION POWER GAIN vs. COLLECTOR CURRENT





Remark The graphs indicate nominal characteristics.

★ S-PARAMETERS

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

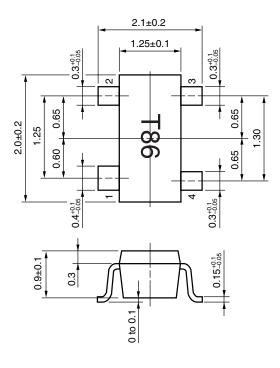
Click here to download S-parameters.

 $[\mathsf{RF} \ \mathsf{and} \ \mathsf{Microwave}] \to [\mathsf{Device} \ \mathsf{Parameters}]$

URL http://www.ncsd.necel.com/

★ PACKAGE DIMENSIONS

4-PIN SUPER MINIMOLD (UNIT: mm)



PIN CONNECTIONS

- 1. Collector
- 2. Emitter
- 3. Base
- 4. Emitter

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